

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>TOSHIO TAKAHASHI</td> <td>12/04/2013</td> </tr> <tr> <td>HIROHISA WAKISAKA</td> <td>12/04/2013</td> </tr> <tr> <td>KOUICHI MACHIDA</td> <td>12/04/2013</td> </tr> </tbody> </table>		Name	Execution Date	TOSHIO TAKAHASHI	12/04/2013	HIROHISA WAKISAKA	12/04/2013	KOUICHI MACHIDA	12/04/2013
Name	Execution Date								
TOSHIO TAKAHASHI	12/04/2013								
HIROHISA WAKISAKA	12/04/2013								
KOUICHI MACHIDA	12/04/2013								
RECEIVING PARTY DATA									
Name:	IHI CORPORATION								
Street Address:	1-1, TOYOSU 3-CHOME, KOTO-KU								
City:	TOKYO 135-8710								
State/Country:	JAPAN								
PROPERTY NUMBERS Total: 1									
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14125335</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	14125335				
Property Type	Number								
Application Number:	14125335								
CORRESPONDENCE DATA									
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Date:	12/11/2013								
Total Attachments: 1 source=01529342#page1.tif									

OP \$40.00 14125335

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05P49322US

**PATENT APPLICATION ASSIGNMENT
SOLE OR JOINT INVENTORS
EXECUTED OUTSIDE U.S.A.**

**OUR FILE NO. P/2850-512
(28977)**

WHEREAS, I,(We), (1) Toshio TAKAHASHI; and (2) Hirohisa WAKISAKA; and (3) Kouichi MACHIDA as Assignor, have invented certain improvements in

WASTE HEAT POWER GENERATOR

for which an application for United States Letters Patent has been executed by me (us) of even date herewith; and

WHEREAS, IHI Corporation a corporation organized under the laws of Japan and having a principal place of business at 1-1, Toyosu 3-chome, Koto-ku, Tokyo 135-8710 Japan is desirous of acquiring all right, title and interest in and to said invention and any Patent that may be granted therefor.

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, I (We), as assignor(s), hereby sell, assign and set over to said assignee the entire right, title and interest for the United States in and to said invention and the aforesaid application for Patent, all original, divisional, continuation, substitute, reissue or reexamination applications and patents applied for or granted therefor in the United States and all rights for past infringement, and the Commissioner of Patents and Trademarks is hereby authorized and requested to issue all patents on said inventions or resulting therefrom to said assignee herein, as assignee of the entire interest therein; and the undersigned for myself (ourselves) and my (our) legal representatives, heirs and assigns do hereby agree and covenant without further remuneration, to execute and deliver all divisional, continuation, reissue and other applications for Patent on said inventions and all assignments thereof to said assignee or its assigns, to communicate to said assignee or its representatives all facts known to the undersigned respecting said inventions, whenever requested, to testify in any interferences or other legal proceedings in which any of said applications or patents may become involved, to sign all lawful papers, make all rightful oaths, and to do generally everything necessary to assist assignee, its successors, assigns and nominees to obtain patent protection for said invention in the United States, the expenses incident to said applications to be borne and paid by said assignee.

Date: December 4, 2013

Toshio Takahashi
Toshio TAKAHASHI

Date: December 4, 2013

Hirohisa Wakisaka
Hirohisa WAKISAKA

Date: December 4, 2013

Kouichi Machida
Kouichi MACHIDA

LEGALIZATION RECOMMENDED

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